

## \*\*COMPLETE THIS FORM TO INITIATE SUPPLIER SCOUTING\*\*

## **MEPNN Supplier Scouting Opportunity Synopsis**

- \*The submitting entity agrees to notify NIST MEP of the status of actions taken as a result of this scouting instance within 30 days after receiving a results report. For instances where the submitting entity is an MEP Center submitting on behalf of a client, the MEP Center agrees to notify NIST MEP on behalf of their client. For instances where the submission is direct from federal/state agencies or is a private company, the submitting federal/state agency or private company entity agrees to notify NIST MEP. Notification should be via email to scouting@nist.gov, indicating the following:
  - Contact with matches identified in report complete and supply contract awarded, process complete
  - Contact with matches identified in report complete and no supply contract awarded, process complete
  - Contact with matches identified in report complete and supply negotiations underway, process in progress
  - Contact with matches identified in report underway; supply negotiations not yet begun; process in progress
  - Contact with matches identified in report not yet begun, process in progress

•	Contact with matches identifie	d in report will not occur within the next 6-months, process complete			
Automated Singl	le Substrate Resist Develop and Chrome Etch system	days Opportunities will be postedfor 30 days unless specified			
Item to be So	couted				
Please descri	ibe the item application/ the end use of it	tem.* Provide the item number if applicable: (N95 Mask vs Protective Mask).			
The National Institute of Standards and Technology (NIST) seeks information on commercial vendors capable of providing an automated, single substrate, resist development and chrome etch processing system to support nanofabrication in the Center for Nanoscale Science and Technology (CNST) user facility. The system will be sited and used as a shared resource accessible to researchers from industry, academia, NIST, and other government agencies in the CNST NanoFab. The automated, single substrate, resist development and chrome etch processing system is used to develop patterns in photoresist and perform wet chrome etch processing on wafers and photomasks. Applications include fabricating nano-semiconductor and nano-photonic devices.					
2022-13 Supplier Sco	38 outing Number (NIST MEP use)				
333242 Scouting cus	stomer/product <u>NAICS Code</u> , if known				
⊒	a. Type of supplier being	sought*			
ECHNICAL	. ຜູ້	☐ Contract Manufacturer ☐ Distributor			
l <u>'</u> .l	= h Peacon for scouting su	hmission*			

☐ Re-shore

## NFORMATION: a. Describe the manufacturing processes (elaborate to provide as much detail as possible).\* and Performance Item to be purchased as a standalone unit b. Provide dimensions / size / tolerances / performance specifications for the item.\*

☐ 2<sup>nd</sup> Supplier

Other

☐ New Product Startup

this automated, single substrate, resist development and chrome etch processing system is a wet chemical processing tool that uses TMAH-based photoresist developers and ceric ammonium nitrate-based chrome etchants to resolve lithographically defined patterns in photoresists and etch the chrome layer on photomasks. This new single substrate processing system will be used to simplify and standardize resist development and chrome etch processes, help to minimize chemical usage, improve process repeatability, improve safety for the facility users. 1. The system shall have the following configuration: 1) A process chamber that is compatible with tetramethyl ammonium hydroxide (TMAH) based photoresist developers and ceric ammonium nitrate-based chrome etch chemistries. 2) Chemical delivery hardware capable of handling two separate developers and chrome etch chemistry. 3) Chemical source hardware shall be capable of using chemicals in the one-gallon source bottles as delivered by OEM chemical suppliers. 4) Chemical source hardware shall be designed for easy and rapid replacement of source chemicals. 5) A chemical drain shall be equipped with a diverter to allow for the developer to follow one path and the chrome etchant to follow a separate path. 6) The software shall support both manual and automatic operation. 7) The system shall have safety interlocks to keep NanoFab user community safe. 2. Wafer compatibility and wafer heating: 1) The system shall be able to process 100 mm and 150 mm diameter semi-spec silicon wafers. 2) The system shall be able to process photomasks with following dimensions: a. 5 inch square, 0.090-inch-thick quartz photomasks b. 6 inch square, 0.120-inch-thick

☐ Past supplier no longer available



•		quartz photomasks c. 6 inch square, 0.250-inch-thick (6025) semi spec quartz photomasks 3. Established process library: 1) The system shall have established base line processes for etching chrome from semi spec: a. 5 inch square, 0.090-inch-thick quartz photomasks b. 6 inch square, 0.120-inch-thick quartz photomasks c. 6 inch square, 0.250-inch-thick (6025) semi spec quartz photomasks 2) The system shall have established base line processes for developing positive tone resists using CF26 TMAH based developer on: a. 100 mm and 150 mm semi spec silicon substrates b. 5 inch square, 0.090-inch-thick quartz photomasks c. 6 inch square, 0.120-inch-thick quartz photomasks d. 6 inch square, 0.250-inch-thick (6025) semi spec quartz photomasks  c. List required materials needed to make the product, including materials of product components.*  Item to be purchased as a standalone unit
	2.	d. Are there applicable certification requirements?*   Yes  Please explain
	. Summary of Technical Specifications cont:	
	chni	e. Are there applicable regulations?*   Yes  No  Please explain
	ical Specificat	
	ations cont:	f. Are there any other standards, requirements, etc.?*   Yes  No  Please explain
	and Perfor	·
	mano	g. Additional Comments: Is there other information that would impact the item's performance or usefulness? Please explain.
	and Performance Requirements	
BU	3. V Pric	3a. Estimated potential business volume (i.e., # Units Per Day, Month, Year) *:
BUSINESS INFORMATION:	3. Volume and Pricing	One unit
FOR		b. Estimated target price / unit cost information (flexible and negotiable not accepted) *:
MATI		\$700,000.00
NO.	4. D	a. When is it needed by? (Immediate, 30 Days, 6 months, etc.)*
	Delivery	ASAP
		b. Describe packaging requirements (i.e., individually/group packaging)*
	Requirements:	Flexible
	men	c. Where will this item be shipped?*
	ıts:	NIST, 100 Bureau Drive, Gaithersburg, MD 20899



	5. /	Is there other information you would like to include?
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	ommer	-
	ents:	

Photos or diagrams of the item (helpful but not required).